



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20190212002.0
Datasheet for CD4069UB
Information Only**

Date: February 12, 2019
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
CD4069UBE	null
CD4069UBNSR	null
CD4069UBPWR	null
CD4069UBM96	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20190212002.0	PCN Date:	February 12, 2019
Title:	Datasheet for CD4069UB		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification.
The product datasheet(s) is being updated as summarized below.
The following change history provides further details.



CD4069UB

SCHS054E – NOVEMBER 1998 – REVISED JANUARY 2019

Changes from Revision D (February 2016) to Revision E

Page

• Removed artifact "–" at t_{PHL} term on the second Features bullet	1
• Corrected V_I spec MIN/MAX values in the Abs Max Ratings table	4
• Corrected parameter I_{DD} max term to I_{DD} in the Elec Characteristics table	5
• Corrected parameter I_{OL} min term to I_{OL} in the Elec Characteristics table	5
• Corrected parameter V_{OL} max term to V_{OL} in the Elec Characteristics table	6
• Corrected parameter V_{IL} max term to V_{IL} in the Elec Characteristics table	6
• Corrected parameter V_{IH} min term to V_{IH} in the Elec Characteristics table	6
• Corrected parameter I_{IN} max term to I_{IN} in the Elec Characteristics table	7
• Added Y-axis label to Figure 1 image object	8
• Changed text string from "– t_{PHL} " to "of t_{PHL} " in the Feature Description paragraph.	13

The datasheet number will be changing.

Device Family	Change From:	Change To:
CD4069UB	SCHS054D	SCHS054E

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/CD4069UB>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

CD4069UBE	CD4069UBEE4	CD4069UBF	CD4069UBF3A
CD4069UBM	CD4069UBM96	CD4069UBMT	CD4069UBNSR
CD4069UBPW	CD4069UBPWG4	CD4069UBPWR	JM38510/17401BCA
M38510/17401BCA			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com

Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com